

MGV High Current Molded SMT Power Inductors MGV0604 Series

FEATURES AND APPLICATIONS

Laird MGV series high current power inductors improve performance, reliability and power efficiency. A lower profile benefits consumer electronics and telecom design. Products feature extremely low DCR with greater efficiency and enable a large current in a small size. Inductors are of magnetic shielding and molded construction and perform in operating temperatures ranging from -40 C to 125 C including self-heating rise in temperature.

FEATURES

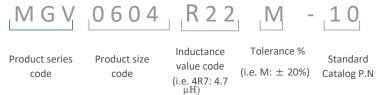
- · Magnetic shielded structure
- Low DCR and high efficiency
- Low profile and miniaturization
- High reliability

APPLICATIONS

- DC-DC Converter and Power Suppliers
- LCD TV'S and Gaming Console
- Tablet, Notebooks, Servers and Printers
- Networking and Data storage
- GPS, Set-top-box and Base stations
- Smart meters and Medical instruments



PART NUMBER EXPLANATION



Note: Automotive grade parts are also available, a specific P.N will be assigned upon request. Please contact laird local sales for details.

ELECTRICAL SPECIFICATIONS

- Tolerance: M: ±20% or N: ±30%
- Inductance tested at 100KHz, 1.0V
- Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C)
- Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C)
- Operating temperature range: -40°C~+125°C (including self-heating temperature rise)
- Storage temperature range (packaging conditions): -10°C~+40°C and RH 60%(MAX.)

Note: Heat Rated Current (Irms) is tested on a typical PCB and apply a constant current in still air.

The temperature rise is dependent on the application system condition including PCB PAD pattern, trace width and thickness and adjacent components etc. It's suggested to verify the temperature rise of the component under the real operation application conditions.



Molded SMT Power Inductors

www.laird.com	MGV0604 S	eries Rev:
		(UNIT: mn
	Α	7.30±0.50
	В	6.70±0.30
	С	4.00 Max
+	D	2.90±0.30
<u> </u>	Е	1.60±0.50
E	L	8.40 ref
- D -	G	2.50 ref
'	Н	3.50 ref
L	REN	IARK
G -		
Ţ		
: Inductance Tolerance. (M=±20% ,N=±	:30%)
"X"=0:Standard catalog	part number	
"V" 4 O.Controlled susta		
"X"=1-9:Controlled custo	mized part or	different
performance than s		
	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
performance than s	td catalog part	
	: Inductance Tolerance. (A B C D E L G H REM : Inductance Tolerance. (M=±20%, N=±20%, N=±20%)



Molded SMT Power Inductors

www.laird.com MGV0604 Series Rev: A **SPECIFICATION** INDUCTANCE **PART NUMBER** Irms(A) Typ. Isat(A) Typ. DCR(mΩ) Typ DCR(mΩ) Max **REMARK** (uH)±20% MGV0604R13M-10 0.13 42.0 52.0 0.70 1.2 MGV0604R22M-10 0.22 45.0 0.90 34.0 1.3 **GENERAL SPECIFICATION:** Inductance tested at 100KHz, 0.25V • Heat Rated Current (Irms) is defined based on temperature rise approximate 40°C without core loss (ambient temperature 25±5°C) Saturation Current (Isat) is the DC current at which the inductance drops off approximately 30% from its value without current. (ambient temperature 25±5°C) • Operating temperature range: -40°C~+125°C (including self-heating temperature rise) Storage temperature range (packaging conditions): -10°C~+40°C and RH 60%(MAX.)

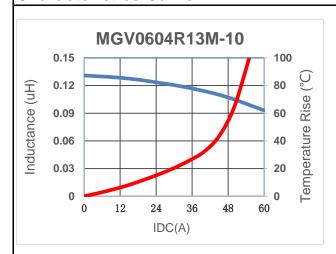


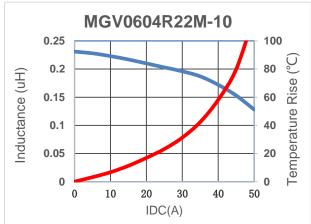
Molded SMT Power Inductors

www.laird.com MGV0604 Series Rev: A

SPECIFICATION

Characteristics Curve



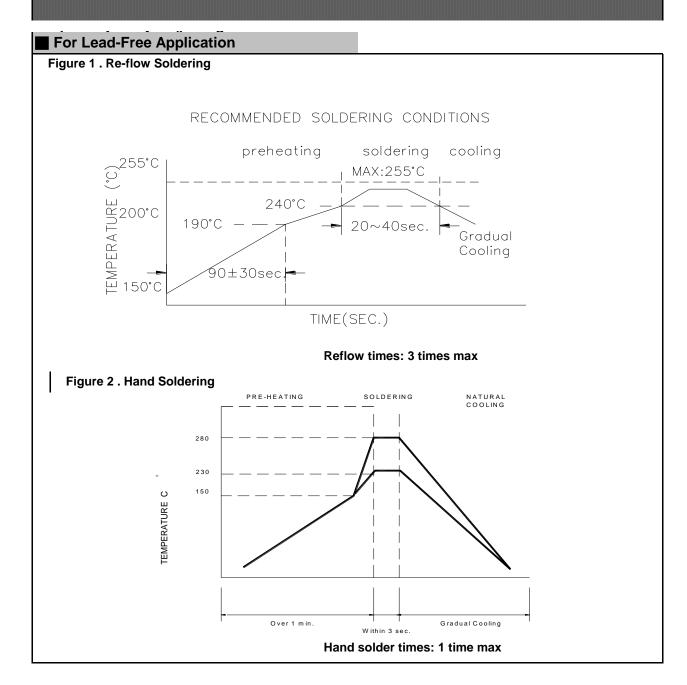




Molded SMT Power Inductors

www.laird.com MGV0604 Series Rev: A

Recommended Soldering Conditions





Molded SMT Power Inductors

www.laird.com MGV0604 Series Rev: A

	SMD series(Co	nsumer)	
Item	Reference	Additional Requirements	
Operating temperature range	-55°C ~ +125°C (Including self-temperature rise)		
Storage temperature and humidity range	-10 $^\circ$ C to +40 $^\circ$ C , 60% RH Max		
High Temperature Exposure (Storage)	MIL-STD-202 Method 108	85±2℃, 168+24hours	
Temperature Cycling	JESD22 Method JA-104	-40°C →+85, transforming interval:20s, 100cycles	
Operational Life	MIL-PRF-2	85±℃, 168+24hours Apply maximum rated voltage and current according part drawing	
External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking and workmanship. Electrost not required.	
Physical Dimension	JESD22 Method JB-100	Verify physical dimensions to the applicable device detail specification. Note: User(s) and Suppliers spec. Electrical Tenot required	
Vibration	MIL-STD-202 Method 204	10~55Hz,1.5mm, 2 hours in each 3mutually perpendicular directions (total of 6 hours)	
Resistance to Soldering Heat	MIL-STD-202 Method 210	1. Max. 260±5°C,10±1s, 2 times 2.Solder Composition: Sn/3Ag/0.5Cu	
Solderability	J-STD-002	245±5 [°] C, 5±1sec, Solder: Sn/3.0Ag/0.5Cu	
Electrical Characterization	Print Spec	Parametrically test per lot and sample size requirements, summary to show Min, Max, Mean and Standard deviation at room as well as Min and Max Operating temperatures	
Board Flex	AEC-Q200-005	2mm,30±1s	
Terminal Strength(SMD)	AEC-Q200-006	10N, 5S, X,Y direct	

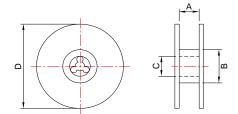


Molded SMT Power Inductors

www.laird.com MGV0604 Series Rev: A

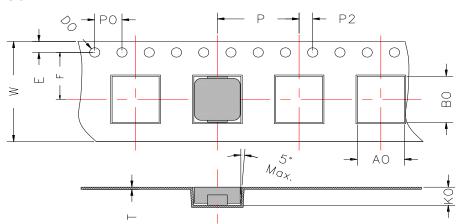
PACKAGING

Reel Dimension



			C(mm)	
13'x16	16.4+2/-0	100 ± 2	13+0.5/-0.2	330

Tape Dimension

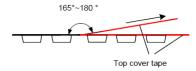


W	E	F	Р	A0	В0	P2	P0	K0	t	D0
16.0±0.3	1.75±0.1	7.50±0.1	12.00±0.1	7.00±0.1	7.70±0.1	2.0±0.1	4.0±0.1	5.3±0.1	0.35±0.05	1.5Ref

Packaging Quantity

P/N	P/N Chip/Reel		Outer Box
MGV0604 800pcs		1600pcs	3200pcs
Size	Э	-	-

Peeling Off Force



The force peeling off cove tape is 10 to 100 grams					
in the arrow direction under the following conditions					
Room Temp	Room	Room atrn	Teaming		
(°C) Humidity		(hPa)	Speed		
5~35 45~85		860~1060	300		

- **XStorage Conditions**1. Temperature and humidity conditions: -10-+40℃ and 60% RH.
- 2. Recommended products should be used within 12 month from the time of manufacturing.
- 3. The packaging material should be kept where no chloring or sulfur exists in the air.
- 4. Allowable stacking condition of Packaging box: max height 1.5m or 5 boxes stacking

单击下面可查看定价,库存,交付和生命周期等信息

>>Laird(莱尔德)